

DEC 15 2005

TRANSMITTAL OF FORMAL DRAWINGS

Docket No.
MCT.0012D1US (97-0141.02)

Application Of: **Salman Akram**

Application No.	Filing Date	Examiner	Customer No.	Group Art Unit	Confirmation No.
09/853,111	May 10, 2001	Alonzo Chambliss	21906	2814	7172

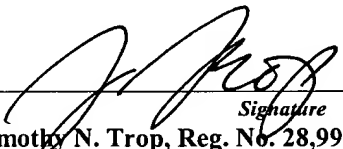
Invention: **Method of Fabricating Mounted Multiple Semiconductor Dies in a Package**

Address to:
**Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**


Transmitted herewith are:

3 sheets of formal drawing(s) for this application.

☒ Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).


Signature
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Dated: **December 12, 2005**

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on
December 12, 2005
(Date)

Signature of Person Mailing Correspondence
Cynthia L. Hayden
Typed or Printed Name of Person Mailing Correspondence